Ref. No: BPP/Notice/HOD/EIL/002/2019

Date: 24.07.2019

NOTICE

With reference to notification no. BPP/Notice/HOD/EIL/001/2019 dated 08.06.2019 the last date of submission of hardcopy application for enrollment into Embedded System & IoT Lab (TI Innovation Lab), TI University Program, is extended to 27.07.2019 (5 pm). The revised schedule is given below:

Last date of submission of application:	27th July, 2019 (5 pm) at B-606
Date of entrance and/or interview:	1st – 3rd August, 2019
Venue of entrance test:	ECE Department
Reporting time for entrance test:	4:40 pm

The list of students eligible for entrance test/interview and exam room no. will be notified through email by 29.07.2019.

Contacts: Mr. Prasenjit Kr. Mudi (6290006234), Room-606, B-Block, BPPIMT
Mr. Ramesh Kumar (7074218296), Room-505, B-Block, BPPIMT

For details: http://bppimt.ac.in/ECE.aspx?val=Notice
Note: All the classes and sessional will be as per schedule.

Dr. Ivy Majumdar
(HOD, ECE Dept.)

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1. Principal's Office
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